Fuseholder Open Design, Holder for MSx 250, THT

250 VAC/DC · 6.3 A (UL/CSA)

Description
- Through hole mounting

Standards
- UL 4248-1 / UL 512
- CSA 4248-1 / no. 39

Approvals
- UL File Number: E39328

References

Fuseholder to MSF 250; MST 250; MSTU 250; MSU 250; MXT 250

Weblinks
pdf-datasheet, html-datasheet, General Product Information, Approvals, CE declaration of conformity, RoHS, CHINA-RoHS, e-Shop, SCHURTER-Stock-Check, Distributor-Stock-Check, Detailed request for product

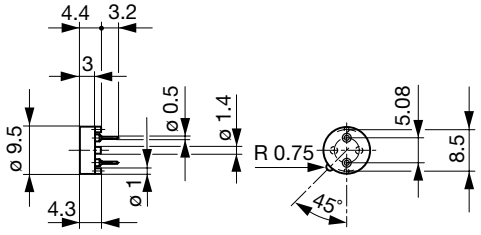
Technical Data

Fuse-Link	Microfuse 250 V
Mounting	PCB
Terminal	Solder THT
Rated Voltage	250 VAC/DC
Rated current	6.3 A (UL/CSA)
Degree of Protection	IP 30
Admissible Ambient Air Temp.	-40 °C to 85 °C
Climatic Category	40/085/21 acc. to IEC 60068-1
Material: Socket	Thermoplastic, UL 94V-0
Material: Terminals	Tin-Plated Copper Alloy
Unit Weight (Socket/Cap)	0.37 g
Storage Conditions	0 °C to 60 °C, max. 70% r.h.
Product Marking	

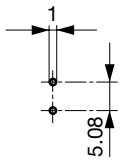
Soldering Methods	Wave
Solderability	235 °C / 2 sec acc. to IEC 60068-2-20, Test Ta, method 1
Resistance to Soldering Heat	260 °C / 10 sec acc. to IEC 60068-2-20, Test Tb, method 1A
Contact Resistance	< 7 mΩ at 20 mV
Dielectric Strength	> 3 kV (50 Hz; 1 min)
Impulse Withstand Voltage	> 4 kV between L-N
Insulation Resistance	> 10 MΩ between L-N (500 VDC; 1 min)
Overvoltage Category	I - III acc. to IEC 60664-1
Pollution Degree	1 - 3 acc. to IEC 60664-1

Dimensions

7.6 mm



Variant 0031.7601



Drilling diagram

Variants

Holder	Order Number
●	0031.7601

Packaging Unit Plastic box (100 pcs.)

01.07.2013

The specifications, descriptions and illustrations indicated in this document are based on current information. All content is subject to modifications and amendments.